

QUICKSWITCH[®] PRODUCTS HIGH-SPEED CMOS 12-BIT 3-TO-1 BUS-SELECT SWITCH

FEATURES:

- · Enhanced N channel FET with no inherent diode to Vcc
- 5 Ω bidirectional switches connect inputs to outputs
- · Zero propagation delay, zero ground bounce
- · TTL-compatible input and output levels
- · Undershoot clamp diodes on all switch and control inputs
- · Available in SSOP and TSSOP packages

APPLICATIONS:

- · Video, audio, graphics switching, muxing
- · Hot-swapping, hot-docking
- Voltage translation (5V to 3.3V)

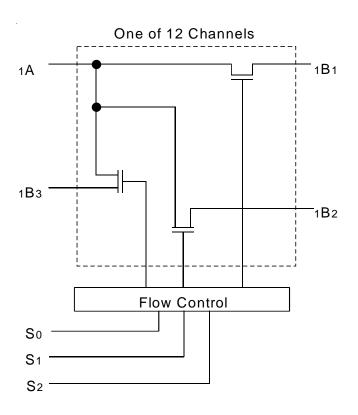
FUNCTIONAL BLOCK DIAGRAM

DESCRIPTION:

The QS316214 provides a set of twelve high-speed CMOS TTLcompatible buses switching between three separate ports. The low ON resistance of the QS316214 allows inputs to be connected to outputs without adding propagation delay and without generating additional ground bounce noise. The device operates as a 12-bit bus-select through the data-select (S0-S2) terminals.

Mux/Demux devices provide an order of magnitude faster speed than equivalent logic devices.

The QS316214 is characterized for operation at -40°C to +85°C.



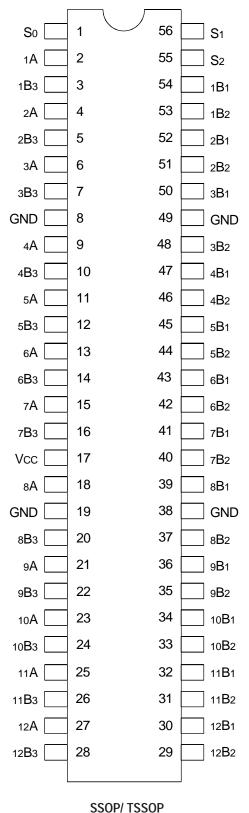
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INDUSTRIAL TEMPERATURE RANGE

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PINCONFIGURATION



TOP VIEW

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Description	Мах	Unit	
VTERM ⁽²⁾	Supply Voltage to Ground	–0.5 to +7	V	
VTERM ⁽³⁾	DC Switch Voltage Vs	–0.5 to +7	V	
VTERM ⁽³⁾	DC Input Voltage VIN	–0.5 to +7	V	
VAC	AC Input Voltage (pulse width ≤20ns)	-3	V	
Ιουτ	DC Output Current	120	mA	
Рмах	Maximum Power Dissipation (T _A = 85°C)	0.93	W	
Tstg	Storage Temperature	-65 to +150	°C	

NOTES:

1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

2. Vcc terminals.

3. All terminals except Vcc .

CAPACITANCE (TA = +25°C, f = 1MHz, VIN = 0V, VOUT = 0V)

Pins		Тур.	Max. ⁽¹⁾	Unit
Control Inputs		5	5.5	рF
Quickswitch Channels	Demux	10	12	pF
(Switch OFF)	Mux	6	7	

NOTE:

1. This parameter is guaranteed but not production tested.

PIN DESCRIPTION

Pin Names	I/O	Description	
1 A - 12 A	I/O	Bus A	
1Bx - 12Bx	I/O	Bus B	
So - S2 I		Data Select	

FUNCTION TABLE⁽¹⁾

S 2	S 1	S0	хА	Function		
L	L	L	Z	Disconnect		
L	L	Н	xB1	xA to xB1		
L	Н	L	xB2	xA to xB2		
L	Н	Н	Z	Disconnect		
Н	L	L	Z	Disconnect		
Н	L	Н	хВз	xA to xB3		
Н	Н	L	xB1	xA to xB1		
Н	Н	Н	xB2	xA to xB2		

NOTE:

1. H = HIGH Voltage Level L = LOW Voltage Level

Z = High-Impedance

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified: Industrial: TA = -40° C to $+85^{\circ}$ C. Vcc = 5V ± 10%

Symbol	Parameter	Test Conditions	Min.	Тур. ⁽¹⁾	Max.	Unit
Vih	Input HIGH Voltage	Guaranteed Logic HIGH for Control Inputs	2	_	_	V
VIL	Input LOW Voltage	Guaranteed Logic LOW for Control Inputs	—	_	0.8	V
lin	Input Leakage Current (Control Inputs)	$0V \le VIN \le VCC$	—	_	±1	μA
loz	Off-State Current (Hi-Z)	$0V \le VOUT \le VCC$	_	_	±1	μA
Ron	Switch ON Resistance	Vcc = Min., VIN = 0V, ION = 30mA	_	5	7	Ω
		Vcc = Min., VIN = 2.4V, ION = 15mA	_	10	12	
Vp	Pass Voltage ⁽²⁾	$VIN = VCC = 5V$, $IOUT = -5\mu A$	3.7	4	4.2	V

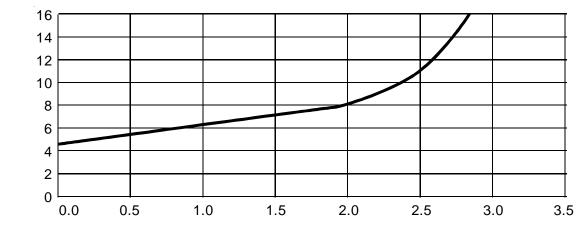
NOTES:

1. Typical values are at Vcc = 5V and Ta = 25° C.

2. Pass voltage is guaranteed but not production tested.

TYPICAL ON RESISTANCE vs VIN AT Vcc = 5V





VIN (Volts)

POWER SUPPLY CHARACTERISTICS

Symbol	Parameter	Test Conditions ⁽¹⁾		Unit
lcco	Quiescent Power Supply Current	Vcc = Max., VIN = GND or Vcc, f = 0	3	μA
Δlcc	Power Supply Current per Control Input HIGH ⁽²⁾	Vcc = Max., VIN = 3.4V, f = 0	2.5	mA
ICCD	Dynamic Power Supply Current per MHz ⁽³⁾	Vcc = Max., A and B Pins Open, Control Inputs Toggling @ 50% Duty Cycle	0.25	mA/MHz

NOTES:

1. For conditions shown as Min. or Max., use the appropriate values specified under DC Electrical Characteristics.

2. Per TTL-driven input (VIN = 3.4V). A and B pins do not contribute to Δ Icc.

3. This current applies to the control inputs only and represents the current required to switch internal capacitance at the specified frequency. The A and B inputs generate no significant AC or DC currents as they transition. This parameter is guaranteed but not production tested.

SWITCHING CHARACTERISTICS OVER OPERATING RANGE

 $T_A = -40^{\circ}C \text{ to } +85^{\circ}C, V_{CC} = 5V \pm 10\%$

CLOAD = 50pF, RLOAD = 500Ω unless otherwise noted.

Symbol	Parameter	Min. ⁽¹⁾	Тур.	Max.	Unit
t PLH	Data Propagation Delay ⁽²⁾		_	0.25 ⁽³⁾	ns
t PHL	xA to xBx, xBx to xA				
tPZL	Switch Turn-On Delay	1.5	_	6.5	ns
tрzн	Sx to xA, xBx				
tPLZ	Switch Turn-Off Delay ⁽²⁾	1.5		5.8	ns
tPHZ	Sx to xA, xBx				

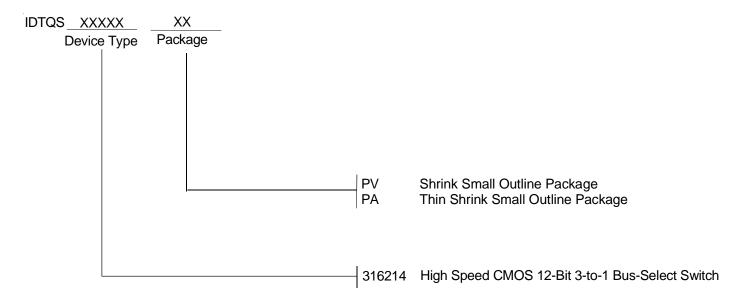
NOTES:

1. Minimums are guaranteed but not production tested.

2. This parameter is guaranteed but not production tested.

^{3.} The bus switch contributes no propagation delay other than the RC delay of the ON resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.25ns at CL = 50pF. Since this time constant is much smaller than the rise and fall times of typical driving signals, it adds very little propagation delay to the system. Propagation delay of the bus switch, when used in a system, is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

ORDERING INFORMATION





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